

1 Overview

STC8H series of microcontrollers do not require an external crystal oscillator and external reset circuit. They are 8051 microcontrollers with the properties of strong anti-interference/ultra low price/high speed/low power consumption. Under the same operating frequency, STC8H series of microcontrollers are about 12 times faster (11.2 ~ 13.2 times) than traditional 8051. To execute all 111 instructions in sequence, the STC8H series microcontroller only needs 147 clocks, while the traditional 8051 requires 1944 clocks. STC8H series of microcontrollers are single clock/machine cycle (1T) microcontrollers produced by STC. They are new generation 8051 microcontrollers with wide voltage/high speed / high reliability / low power consumption / strong antistatic / strong anti-interference, and is super encrypted. The instruction codes are fully compatible with traditional 8051.

High precision of $\pm 0.3\%$ @+25 °C RC clock is integrated in MCU with -1.38% to $+1.42\%$ temperature drift under the temperature range of -40 °C to $+85\text{ °C}$, and 0.88% to $+1.05\%$ temperature drift under temperature range from -20 °C to $+65\text{ °C}$. The frequency of RC clock can be set from 4MHz to 35MHz when programming a MCU using ISP. **Note: The maximum frequency must be controlled below 35MHz when the temperature range is -40 °C to $+85\text{ °C}$.** Moreover, high reliable reset circuit is integrated in MCU with 4 levels optional reset threshold voltages, which can be selected when user programming using ISP. So, external expensive crystal and the external reset circuit can be eliminated completely.

There are three optional clock sources inside the MCU, internal high precision IRC which can be adjusted appropriately, internal 32KHz low speed IRC, external 4MHz~33MHz oscillator or external clock signal. The clock source can be freely chosen in user codes. After the clock source is selected, it may be 8-bit divided and then be supplied to the CPU and the peripherals, such as timers, UARTs, SPI, and so on.

Two low power modes are provided in MCU, the IDLE mode and the STOP mode. In IDLE mode, MCU stops clocking CPU, CPU stops executing instructions without clock, while all peripherals are still working. At this moment, the power consumption is about 1.0mA at 6MHz working frequency. The STOP mode is the power off or power-down mode. At this moment, the main clock stops, CPU and all peripherals stop working, and the power consumption can be reduced to about 0.6uA when VCC is 5.0V, 0.4uA when VCC is 3.3V.

The Power-down mode can be woke-up by one of the following interrupts: INT0(P3.2), INT1(P3.3), INT2(P3.6), INT3(P3.7), INT4(P3.0), T0(P3.4), T1(P3.5), T2(P1.2), T3(P0.4), T4(P0.6), RXD(P3.0/P3.6/P1.6/P4.3), RXD2(P1.0/P4.6), RXD3(P0.0/P5.0), RXD4(P0.2/P5.2), I2C_SDA(P1.4/P2.4/P3.3), Comparator, LVD, Power-down wake-up timer.

Rich digital peripherals and analog peripherals are provided in MCU, including UARTs, timers, enhanced PWMs and I2C, SPI, USB, ultra-high speed ADC and comparator, which can meet the requirements of users when designing a product.

The enhanced dual data pointers are integrated in the STC8H series of microcontrollers. Using user codes, the function of automatic increasing or decreasing of data pointer and automatic switching of two sets of data pointers can be realized.

Products Line	I/O	UART	Timers	ADC	Enhanced PWM	CMP	SPI	I2C	USB	MDU16	LED DRV	Touch Key	RTC	I/O Int.	Color LCM	LCD DRV	DMA
STC8H1K08 family	17	2	3	9 _{CH} *10 _B	●	●	●	●									
STC8H1K28 family	29	2	5	12 _{CH} *10 _B	●	●	●	●									
STC8H3K64S4 family	45	4	5	12 _{CH} *12 _B	●	●	●	●		●				●			
STC8H3K64S2 family	45	2	5	12 _{CH} *12 _B	●	●	●	●		●				●			
STC8H8K64U family Version A	60	4	5	15 _{CH} *12 _B	●	●	●	●	●	●							
STC8H8K64U family Version B	60	4	5	15 _{CH} *12 _B	●	●	●	●	●	●			●	●	●		●
STC8H2K64T family	44	4	5	15 _{CH} *12 _B	●	●	●	●		●	●	●	●	●			
STC8H4K64TLR family	44	4	5	15 _{CH} *12 _B	●	●	●	●		●	●	●	●	●	●		●
STC8H4K64TLCD family	60	4	5	15 _{CH} *12 _B	●	●	●	●		●		●	●	●	●	●	●
STC8H4K64LCD family	61	4	5	15 _{CH} *12 _B	●	●	●	●		●			●	●	●	●	●
STC8H1K08TR family	16	2	3	15 _{CH} *12 _B	●	●	●	●		●		●	●	●	●		●

2 Features

2.1 STC8H3K64S4-45I-LQFP48/32, QFN48/32, TSSOP20 family

2.1.1 Features and Price(Quasi 16-bit MCU with 16-bit hardware multiplier and divider MDU16)

➤ Selection and price (No external crystal and external reset required with 12 channels 12-bit ADC)

MCU	products supply information																Available																
	QFN32<4mm*4mm>	LQFP32<9mm*9mm>	QFN48 <6mm*6mm>	LQFP48 <9mm*9mm>	Online debug itself	Support software USB download directly	Support RS485 download	Password can be set for next update	Program encrypted transmission (Anti-blocking)	Clock output and Reset	Internal high precision Clock (adjustal under 45MHz)	Internal high reliable reset circuit with 4 levels optional reset threshold voltage	Watch-dog Timer	Internal LVD interrupt (can wake-up CPU)	Comparator (May be used as ADC to detect external power-down)	12-bit high speed ADC (8 PWMs can be used as 8 DACs)	Power-down Wake-up timer	16-bit advanced PWM timer with Complementary symmetrical dead-time	Timers/Counters (T0-T4 Pin Can wake-up CPU)	MDU16 (Hardware 16-bit Multiplier and Divider)	I ² C which can wake-up CPU	SPI which can wake-up CPU	UARTs which can wake-up CPU	All I/O ports support interrupts and can wake up MCU	Traditional I/O interrupt(INT0/INT1/INT2/INT3/INT4) (can wake-up CPU)	Maximum I/O Lines	EEPROM 100 thousand times) (Byte)	Enhanced Dual DPTR increasing or decreasing	xdata Internal extended SRAM (Byte)	idata Internal DATA RAM (Byte)	Flash Code Memory (100 thousand times) (Byte)	Operating voltage (V)	
STC8H3K32S4	+	+	+	+	+	+	+	+	+	+	+	+	+	+	+	12bit	+	+	+	+	+	+	+	+	+	32K	43	2	2	3K	256	48K	1.9-5.5
STC8H3K48S4	+	+	+	+	+	+	+	+	+	+	+	+	+	+	+	12bit	+	+	+	+	+	+	+	+	+	32K	43	2	2	3K	256	48K	1.9-5.5
STC8H3K60S4	+	+	+	+	+	+	+	+	+	+	+	+	+	+	+	12bit	+	+	+	+	+	+	+	+	+	4K	43	2	2	3K	256	60K	1.9-5.5
STC8H3K64S4	+	+	+	+	+	+	+	+	+	+	+	+	+	+	+	12bit	+	+	+	+	+	+	+	+	+	IAP	43	2	2	3K	256	64K	1.9-5.5

➤ Core

- ✓ Ultra-high speed 8051 Core with single clock per machine cycle, which is called 1T and the speed is about 12 times faster than traditional 8051
- ✓ Fully compatible instruction set with traditional 8051
- ✓ 21 interrupt sources and 4 interrupt priority levels
- ✓ Online debugging is supported

➤ Operating voltage

- ✓ 1.9V~5.5V

➤ Operating temperature

- ✓ -40°C~85°C (In order to work in a wider temperature range, please use an external clock or use a lower operating frequency)

➤ Flash memory

- ✓ Up to 64Kbytes of Flash memory to be used for storing user code
- ✓ Configurable EEPROM size, 512bytes single page for being erased, which can be repeatedly erased more than 100 thousand times.
- ✓ In-System-Programming, ISP in short, can be used to update the application code. No special programmer is needed.
- ✓ Online debugging with single chip is supported, and no special emulator is needed. The number of breakpoints is unlimited theoretically.

➤ SRAM

- ✓ 128 bytes internal direct access RAM (DATA, use keyword *data* to declare in C language program)
- ✓ 128 bytes internal indirect access RAM (IDATA, use keyword *idata* to declare in C language program)
- ✓ 3072 bytes internal extended RAM (internal XDATA, use keyword *xdata* to declare in C language program)
- **Clock**
 - ✓ Internal high precise RC clock IRC(IRC for short, ranges from 4MHz to 45MHz), adjustable while ISP and can be divided to lower frequency by user software, 100KHz for instance.
 - ✓ Error: $\pm 0.3\%$ (at the temperature 25°C)
 - ✓ $-1.35\% \sim +1.30\%$ temperature drift (at the temperature range of -40°C to $+85^{\circ}\text{C}$)
 - ✓ $-0.76\% \sim +0.98\%$ temperature drift (at the temperature range of -20°C to 65°C)
 - ✓ Internal 32KHz low speed IRC with large error
 - ✓ External crystal (4MHz~45MHz) and external clock

The three clock sources above can be selected freely by user code.

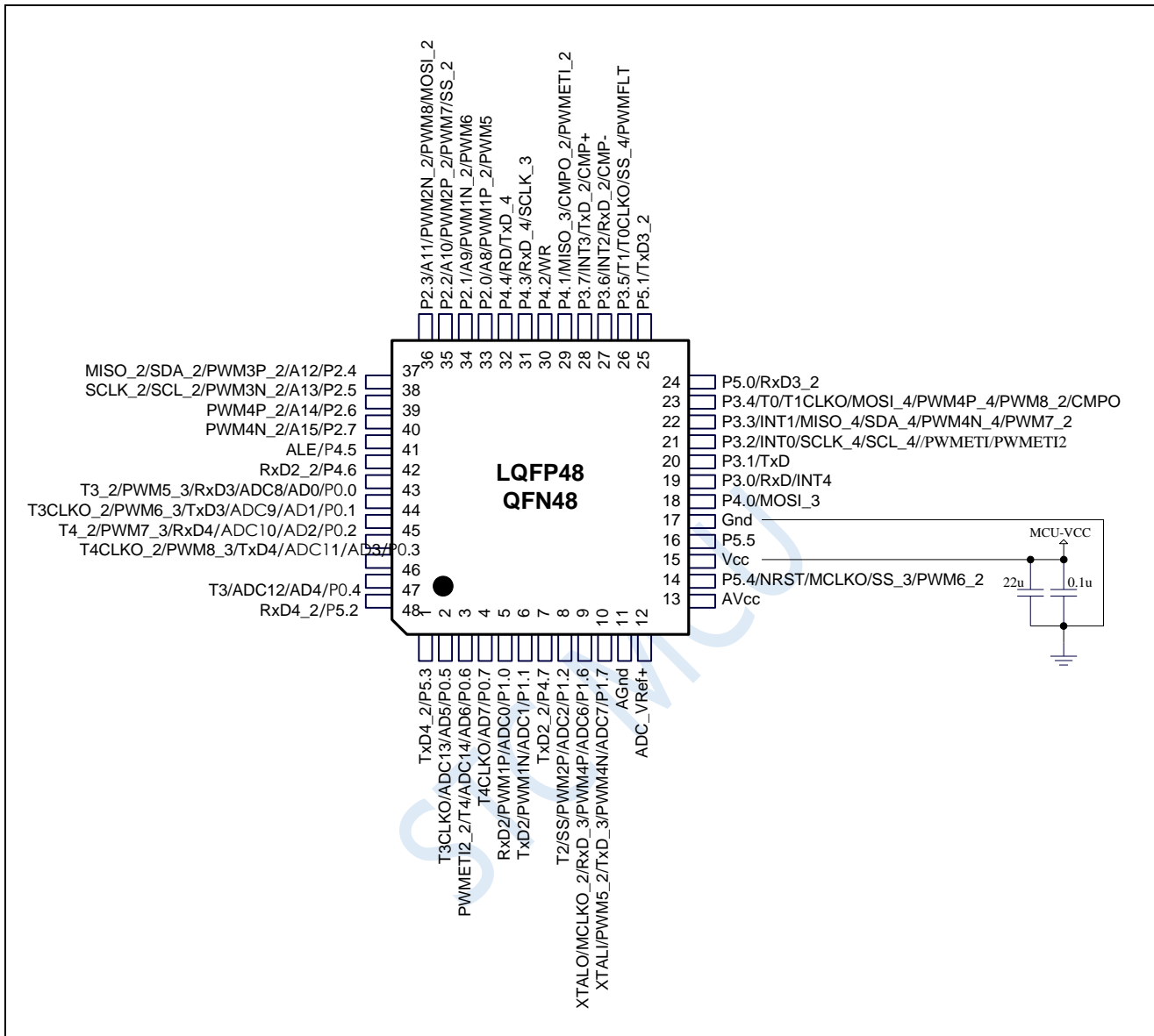
 - ✓ Important note about the internal high-speed IRC of STC8H3K64S4 series B version products
 - ✓ Due to manufacturing reasons, the internal high-speed IRC of some chips may have a blind area between 34MHz and 36MHz. It is recommended not to set the operating frequency in this area.
 - ✓ The temperature drift of the internal high-speed IRC at low temperature is larger than that at the higher temperature, and the temperature drift in the low frequency range is larger than that in the high frequency range. Generally, the operating frequency of 20MHz~40MHz, the temperature drift at 85°C can be controlled within 0.8%.
- **Reset**
 - ✓ Hardware reset
 - ✓ Power-on reset.(Effective when the chip does not enable the low voltage reset function)
 - ✓ Reset by reset pin. The default function of P5.4 is the I/O port. The P5.4 pin can be set as the reset pin while ISP download. (Note: When the P5.4 pin is set as the reset pin, the reset level is low.)
 - ✓ Watch dog timer reset
 - ✓ Low voltage detection reset. 4 low voltage detection levels are provided, 2.0V, 2.4V, V2.7, V3.0.
 - ✓ Software reset
 - ✓ Writing the reset trigger register using software
- **Interrupts**
 - ✓ 21 interrupt sources: INT0(Supports rising edge and falling edge interrupt), INT1(Supports rising edge and falling edge interrupt), INT2(Supports falling edge interrupt only), INT3(Supports falling edge interrupt only), INT4(Supports falling edge interrupt only), timer 0, timer 1, timer 2, timer 3, timer 4, UART 1, UART 2, UART 3, UART 4, ADC, LVD, SPI, I²C, comparator, PWMA, PWMB
 - ✓ 4 interrupt priority levels
 - ✓ interruption that can wake up the CPU in clock stop mode: INT0(P3.2), INT1(P3.3), INT2(P3.6), INT3(P3.7), INT4(P3.0), T0(P3.4), T1(P3.5), T2(P1.2), T3(P0.4), T4(P0.6), RXD(P3.0/P3.6/P1.6/P4.3), RXD2(P1.0/P4.6), RXD3(P0.0/P5.0), RXD4(P0.2/P5.2), I2C_SDA(P1.4/P2.4/P3.3), Comparator interrupt, LVD interrupt, Power-down wake-up timer.
- **Digital peripherals**
 - ✓ 5 16-bit timers: timer0, timer1, timer2, timer3, timer4, where the mode 3 of timer 0 has the Non-Maskable Interrupt (NMI in short) function. Mode 0 of timer 0 and timer 1 is 16-bit Auto-reload mode.
 - ✓ 4 high speed UARTs: UART1, UART 2, UART 3, UART 4, whose maximum baudrate may be FOSC/4.
 - ✓ 8 channels/2 groups of enhanced PWMs, which can realize control signals with dead time, and support external fault detection function. In addition, it also supports 16-bit timers, 8 external interrupts, 8 external captures and pulse width measurement functions.
 - ✓ SPI: Master mode, slave mode or master/slave automatic switch mode are supported.
 - ✓ I²C: Master mode or slave mode are supported.
 - ✓ MDU16: Hardware 16-bit Multiplier and Divider which supports 32-bit divided by 16-bit, 16-bit divided by 16-bit, 16-bit multiplied by 16-bit, data shift, and data normalization operations.
 - ✓ I/O port interrupt: All I/Os support interrupts, each group of I/O interrupts has an independent interrupt entry address, all I/O interrupts can support 4 types interrupt mode: high level interrupt, low level interrupt, rising edge interrupt, falling edge interrupt. (Note: The I/O port interrupts of the STC8H3K64S4 series A version of the chip cannot wake up CPU from power-down. The I/O port interrupts of the B version chip can wake up CPU from power-down, but only have one level of interrupt priority)
- **Analog peripherals**
 - ✓ Ultra high speed ADC which supports 12-bit precision 12 channels analog-to-digital convertors (channel 0 to channel 2, channel 6 to channel 14. No channel 3 and channel 5 because P1.3, P1.4 and P1.5 do not exist). The maximum speed can reach 800K(800K ADC conversions per second)
 - ✓ Channel 15 of ADC is used to test the internal reference voltage. (The default internal reference voltage is 1.19V when the chip is shipped)
 - ✓ A set of comparator (the CMP+ port and all ADC input ports can be selected as the positive terminal of the comparator, so the comparator can be used as a multi-channel comparator for time division multiplexing)
 - ✓ DAC: 8 channels advanced PWMs timers can be used as 8 channels DAC
- **GPIO**
 - ✓ Up to 43 GPIOs: P0.0~P0.7, P1.0~ P1.2, P1.6~ P1.7, P2.0~P2.7, P3.0~P3.7, P4.0~P4.7, P5.0~P5.5
 - ✓ 4 modes for all GPIOs: quasi_bidirectional mode, push-pull outputmode, open drain mode, high-impedance input mode
 - ✓ Except for P3.0 and P3.1, all other I/O ports are in a high-impedance state after power-on. User must set the I/O ports mode before using them. In addition, , the internal 4K pull-up resistor of every I/O can be enabled independently.

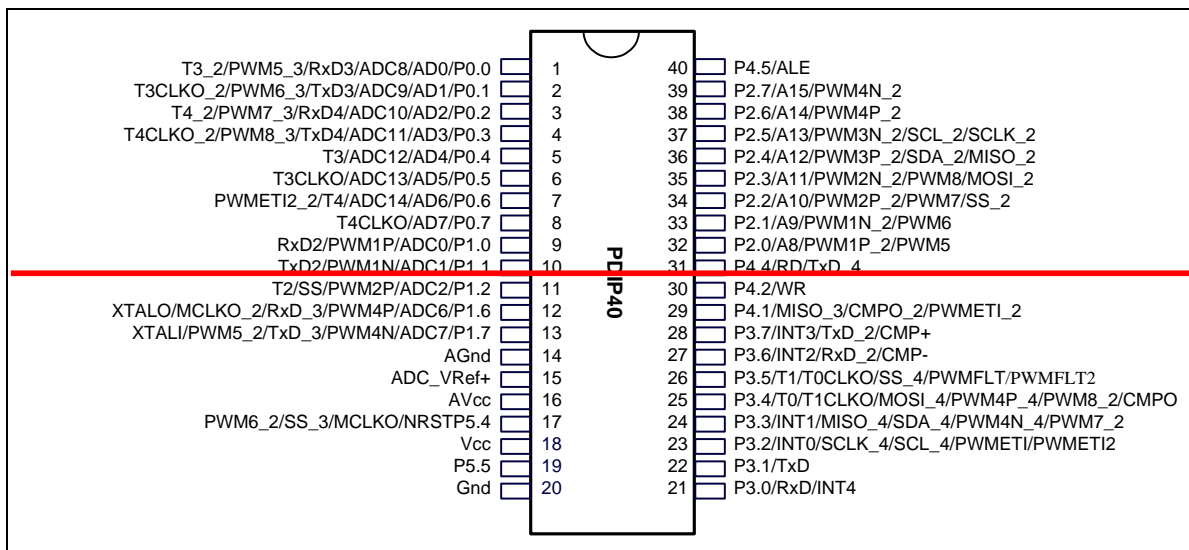
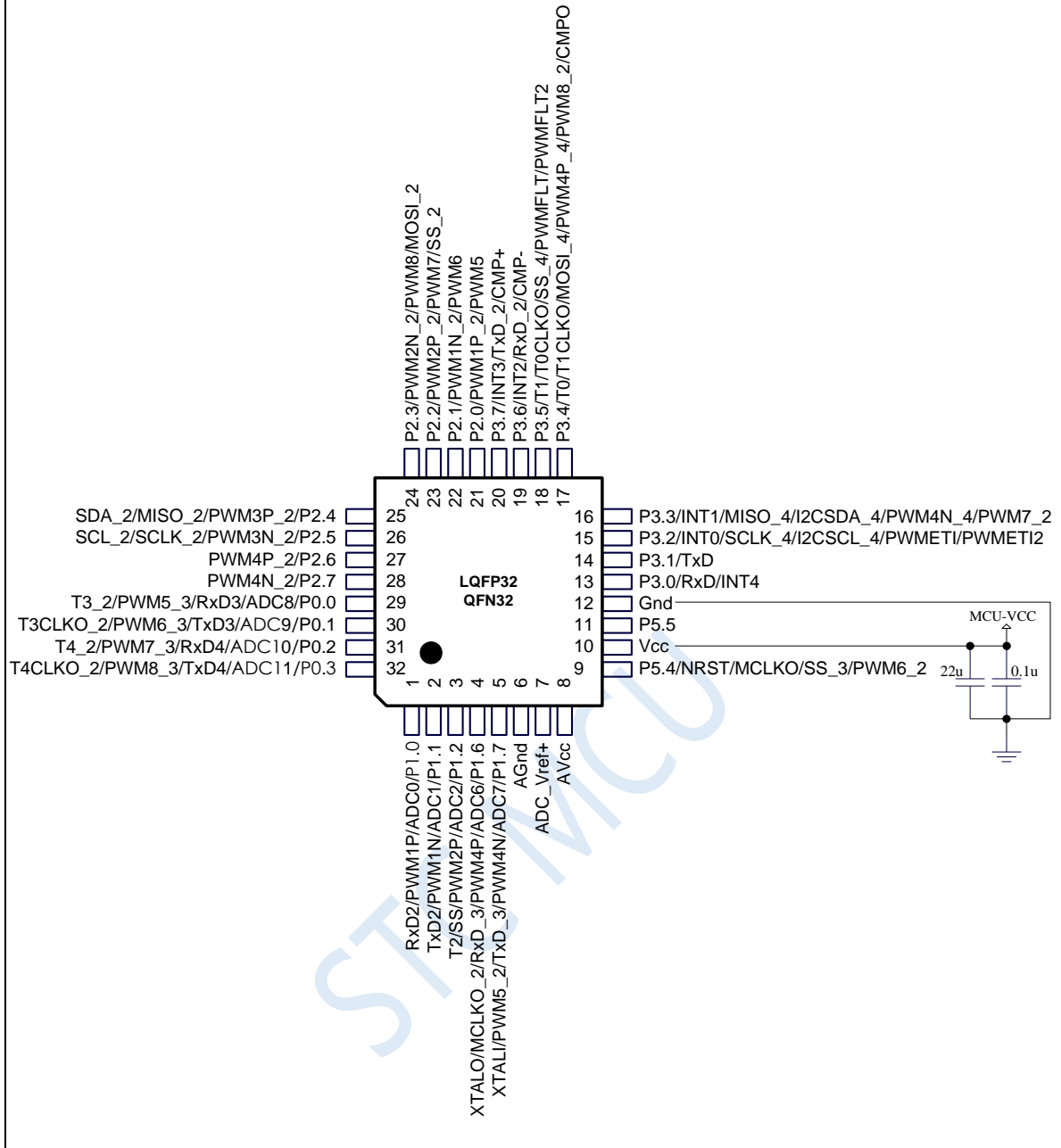
➤ **Package**

- ✓ LQFP48 <9mm*9mm>, QFN48 <6mm*6mm>, LQFP32 <9mm*9mm>, QFN32 <4mm*4mm> (There are no samples for LQFP32, QFN32 at the moment, there will be later, please order in advance if necessary.)

STC MCU

2.1.2 Pinouts





Note:

1. ADC's external reference power supply pin ADC_VRef+ must not be floating. It must be connected to an external reference power supply or directly connected to Vcc.
2. If USB download is not required, P3.0/P3.1/P3.2 cannot be at low level at the same time when the chip is reset.

The download steps using ISP and notes are the same as the circumstances in 2.1.2.

STC MCU

2.1.3 Pin descriptions

Pin number		name	type	description
LQFP48 QFN48	LQFP32 QFN32			
1		P5.3	I/O	Standard IO port
		TxD4_2	O	Transmit pin of UART 4
2		P0.5	I/O	Standard IO port
		AD5	I	Address/data bus
		ADC13	I	ADC analog input 13
		T3CLKO	O	Clock out of timer 3
3		P0.6	I/O	Standard IO port
		AD6	I	Address/data bus
		ADC14	I	ADC analog input 14
		T4	I	Timer4 external input
		PWMFLT2_2	I	Enhance PWM external anomaly detection pin
4		P0.7	I/O	Standard IO port
		AD7	I	Address/data bus
		T4CLKO	O	Clock out of timer 4
5	1	P1.0	I/O	Standard IO port
		ADC0	I	ADC analog input 0
		PWM1P	I/O	Capture of external signal/ Pulse positive output of PWMA
		RxD2	I	Input of UART2
6	2	P1.1	I/O	Standard IO port
		ADC1	I	ADC analog input 1
		PWM1N	I/O	Capture of external signal/ Pulse negative output of PWMA
		TxD2	I	Transmit pin of UART 2
7		P4.7	I/O	Standard IO port
		TxD2_2	I	Transmit pin of UART 2
8	3	P1.2	I/O	Standard IO port
		ADC2	I	ADC analog input 2
		PWM2P	I/O	Capture of external signal/ Pulse positive output of PWM2
		SS	I	Slave selection of SPI (it is output with regard to master)
		T2	I	Timer2 external input
9	4	P1.6	I/O	Standard IO port
		ADC6	I	ADC analog input 6
		RxD_3	I	Input of UART1
		PWM4P	I/O	Capture of external signal/ Pulse positive output of PWM4
		MCLKO_2	O	Main clock output
		XTALO	O	Connect to external oscillator
10	5	P1.7	I/O	Standard IO port
		ADC7	I	ADC analog input 7
		TxD_3	O	Transmit pin of UART 1
		PWM4N	I/O	Capture of external signal/Pulse negative output of PWM4
		PWM5_2	I/O	Capture of external signal/Pulse output of PWM5
		XTALI	I	Connect to external oscillator
11	6	AGnd	Gnd	ADC Ground

Pin number		name	type	description
LQFP48 QFN48	LQFP32 QFN32			
12	7	ADC_VRef+	I	External reference input pin, which can be directly connected to MCU's VCC when the requirements are not high.
13	8	AVcc	Vcc	ADC Power Supply

14	9	P5.4	I/O	Standard IO port
		NRST	I	Reset pin(low level reset)
		MCLKO	O	Main clock output
		SS_3	I	Slave selection of SPI (it is output with regard to master)
		PWM6_2	I/O	Capture of external signal/Pulse output of PWM6
15	10	Vcc	Vcc	Power supply
16	11	P5.5	I/O	Standard IO port
17	12	Gnd	Gnd	Ground
18		P4.0	I/O	Standard IO port
		MOSI_3	I/O	Master Output/Slave Input of SPI
19	13	P3.0	I/O	Standard IO port
		RxD	I	Input of UART1
		INT4	I	External interrupt 4
20	14	P3.1	I/O	Standard IO port
		TxD	O	Transmit pin of UART 1
21	15	P3.2	I/O	Standard IO port
		INT0	I	External interrupt 0
		SCLK_4	I/O	Serial Clock of SPI
		SCL_4	I/O	Serial Clock line of I2C
		PWMET1	I	PWM external trigger input pin
		PWMET2	I	PWM external trigger input pin 2
22	16	P3.3	I/O	Standard IO port
		INT1	I	External interrupt 1
		MISO_4	I/O	Master Input/Slave Output of SPI
		SDA_4	I/O	Serial data line of I2C
		PWM4N_4	I/O	Capture of external signal/Pulse negative output of PWM4
		PWM7_2	I/O	Capture of external signal/ Pulse output of PWM7
23	17	P3.4	I/O	Standard IO port
		T0	I	Timer0 external input
		T1CLKO	O	Clock out of timer 1
		MOSI_4	I/O	Master Output/Slave Input of SPI
		PWM4P_4	I/O	Capture of external signal/ Pulse positive output of PWM4
		PWM8_2	I/O	Capture of external signal/Pulse output of PWM8
24		P5.0	I/O	Standard IO port
		RxD3_2	I	Input of UART3
25		P5.1	I/O	Standard IO port
		TxD3_2	O	Transmit pin of UART 3
26	18	P3.5	I/O	Standard IO port
		T1	I	Timer1 external input
		T0CLKO	O	Clock out of timer 0
		SS_4	I	Slave selection of SPI (it is output with regard to master)
		PWMFLT	I	Enhance PWM external anomaly detection pin

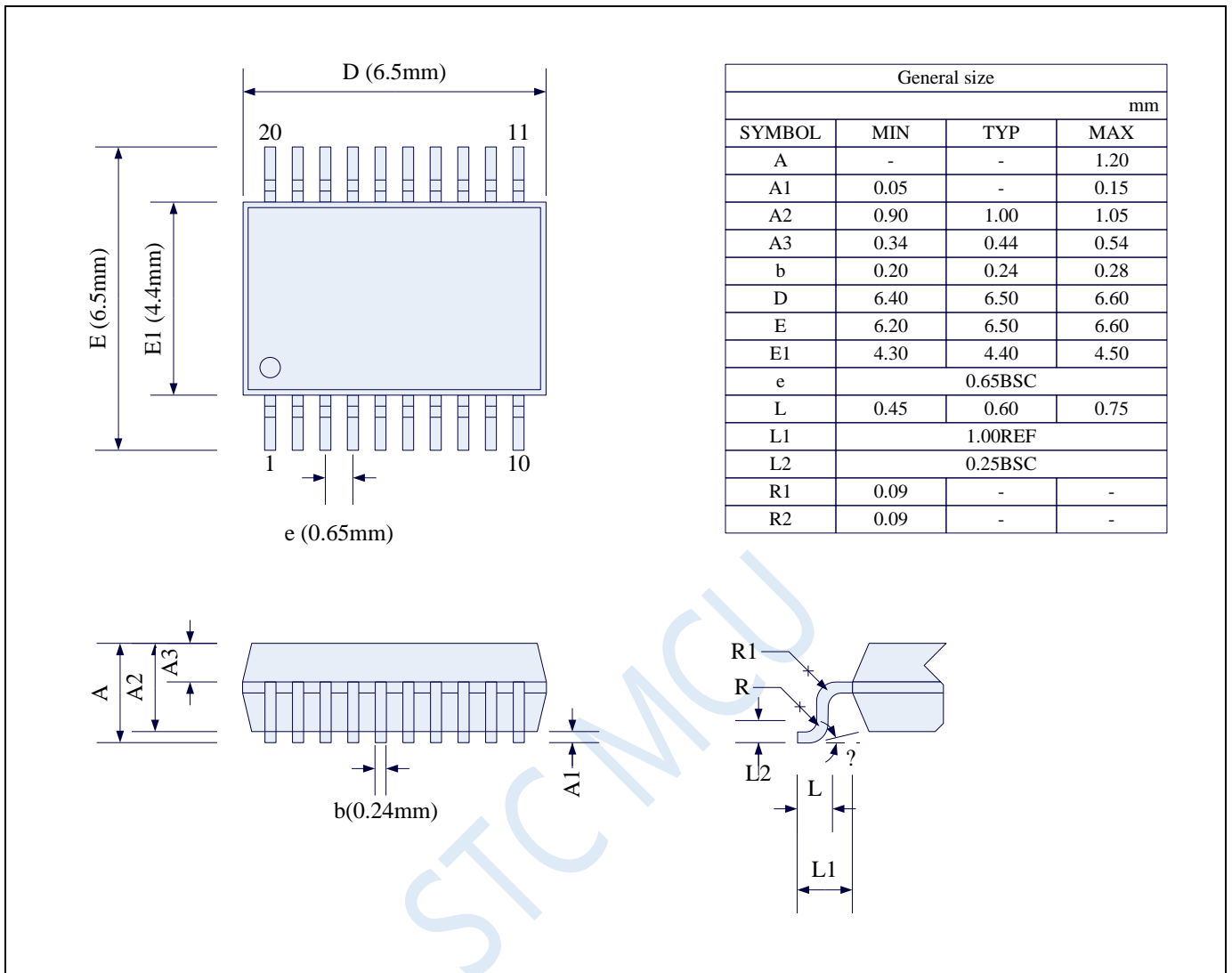
Pin number		name	type	description
LQFP48/QFN48	LQFP32/QFN32			
27	19	P3.6	I/O	Standard IO port
		INT2	I	External interrupt 2
		RxD_2	I	Input of UART1
		CMP-	I	Comparator negative input
28	20	P3.7	I/O	Standard IO port
		INT3	I	External interrupt 3
		TxD_2	O	Transmit pin of UART 1
		CMP+	I	Comparator positive input
29		P4.1	I/O	Standard IO port

		MISO_3	I/O	Master Input/Slave Output of SPI
		CMPO_2	O	Comparator output
		PWMETI_2	I	PWM external trigger input pin
30		P4.2	I/O	Standard IO port
		WR	O	Write signal of external bus
31		P4.3	I/O	Standard IO port
		RxD_4	I	Input of UART1
		SCLK_3	I/O	Serial Clock of SPI
32		P4.4	I/O	Standard IO port
		RD	O	Read signal of external bus
		TxD_4	O	Transmit pin of UART 1
33	21	P2.0	I/O	Standard IO port
		A8	I	Address bus
		PWM1P_2	I/O	Capture of external signal/ Pulse positive output of PWMA
		PWM5	I/O	Capture of external signal/Pulse output of PWM5
34	22	P2.1	I/O	Standard IO port
		A9	I	Address bus
		PWM1N_2	I/O	Capture of external signal/Pulse negative output of PWMA
		PWM6	I/O	Capture of external signal/ Pulse output of PWM6
35	23	P2.2	I/O	Standard IO port
		A10	I	Address bus
		SS_2	I	Slave selection of SPI (it is output with regard to master)
		PWM2P_2	I/O	Capture of external signal/Pulse positive output of PWMB
		PWM7	I/O	Capture of external signal/Pulse output of PWM7
36	24	P2.3	I/O	Standard IO port
		A11	I	Address bus
		MOSI_2	I/O	Master Output/Slave Input of SPI
		PWM2N_2	I/O	Capture of external signal/Pulse negative output of PWMB
		PWM8	I/O	Capture of external signal/Pulse output of PWM8

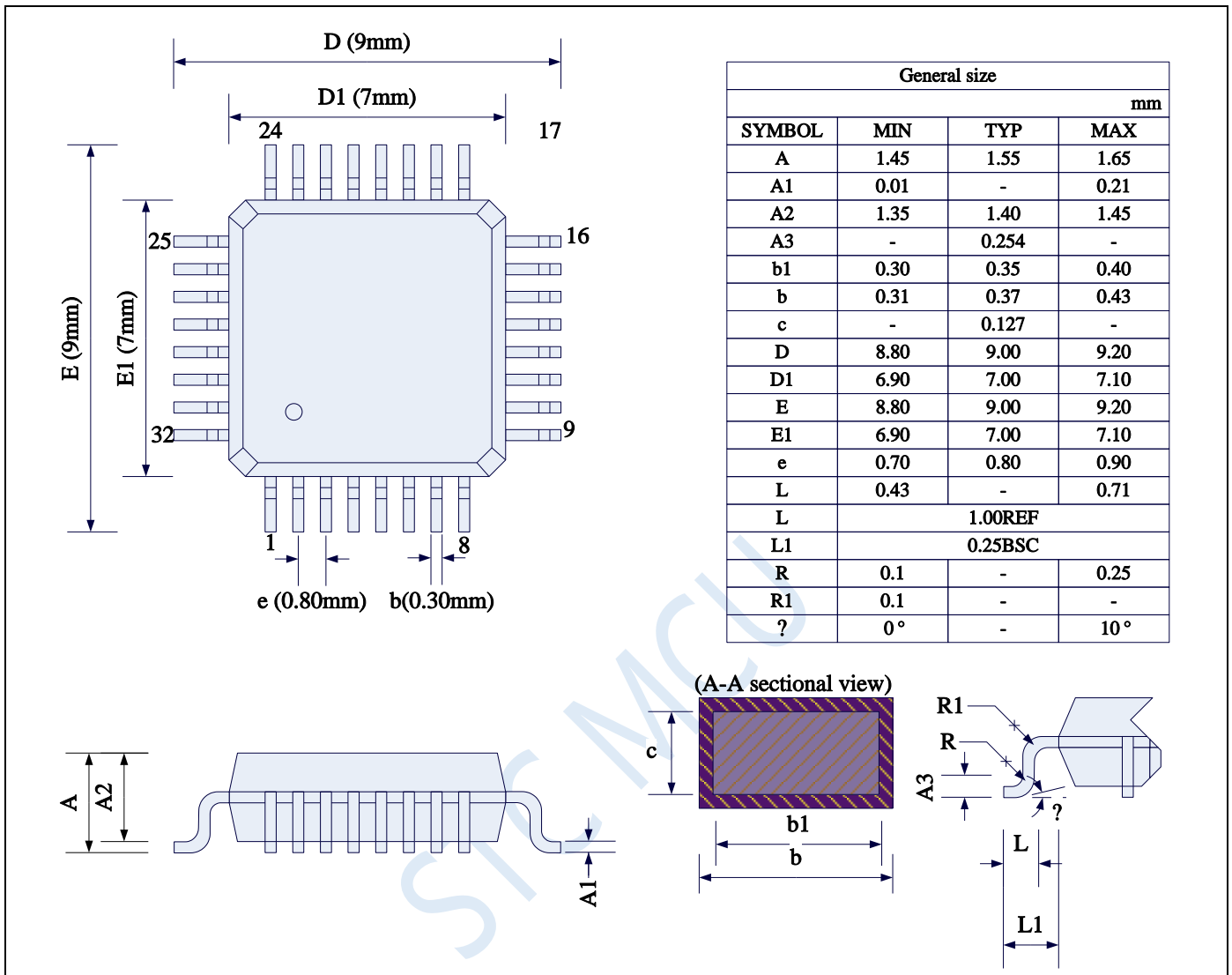
Pin number		name	type	description
LQFP48 QFN48	LQFP32/ QFN32			
37	25	P2.4	I/O	Standard IO port
		A12	I	Address bus
		MISO_2	I/O	Master Input/Slave Output of SPI
		SDA_2	I/O	Serial data line of I2C
		PWM3P_2	I/O	Capture of external signal/ Pulse positive output of PWM3
38	26	P2.5	I/O	Standard IO port
		A13	I	Address bus
		SCLK_2	I/O	Serial Clock of SPI
		SCL_2	I/O	Serial Clock line of I2C
		PWM3N_2	I/O	Capture of external signal/Pulse negative output of PWM3
39	27	P2.6	I/O	Standard IO port
		A14	I	Address bus
		PWM4P_2	I/O	Capture of external signal/Pulse positive output of PWM4
40	28	P2.7	I/O	Standard IO port
		A15	I	Address bus
		PWM4N_2	I/O	Capture of external signal/Pulse negative output of PWM4
41		P4.5	I/O	Standard IO port
		ALE	O	Address Latch Enable signal
42		P4.6	I/O	Standard IO port
		RxD2_2	I	Input of UART2
43	29	P0.0	I/O	Standard IO port
		AD0	I	Address/data bus
		ADC8	I	ADC analog input 8
		RxD3	I	Input of UART3
		PWM5_3	I/O	Capture of external signal/Pulse output of PWM5
		T3_2	I	Timer3 external input
44	30	P0.1	I/O	Standard IO port
		AD1	I	Address/data bus
		ADC9	I	ADC analog input 9
		TxD3	O	Transmit pin of UART 3
		PWM6_3	I/O	Capture of external signal/ Pulse output of PWM6
		T3CLKO_2	O	Clock out of timer 3
45	31	P0.2	I/O	Standard IO port
		AD2	I	Address/data bus
		ADC10	I	ADC analog input 10
		RxD4	I	Input of UART4
		PWM7_3	I/O	Capture of external signal/ Pulse output of PWM7
		T4_2	I	Timer4 external input
46	32	P0.3	I/O	Standard IO port
		AD3	I	Address/data bus
		ADC11	I	ADC analog input 11
		TxD4	O	Transmit pin of UART 4
		PWM8_3	I/O	Capture of external signal/Pulse output of PWM8
		T4CLKO_2	O	Clock out of timer 4
47		P0.4	I/O	Standard IO port
		AD4	I	Address/data bus
		ADC12	I	ADC analog input 12
		T3	I	Timer3 external input
48		P5.2	I/O	Standard IO port
		RxD4_2	I	Input of UART4

3 Package Dimensions

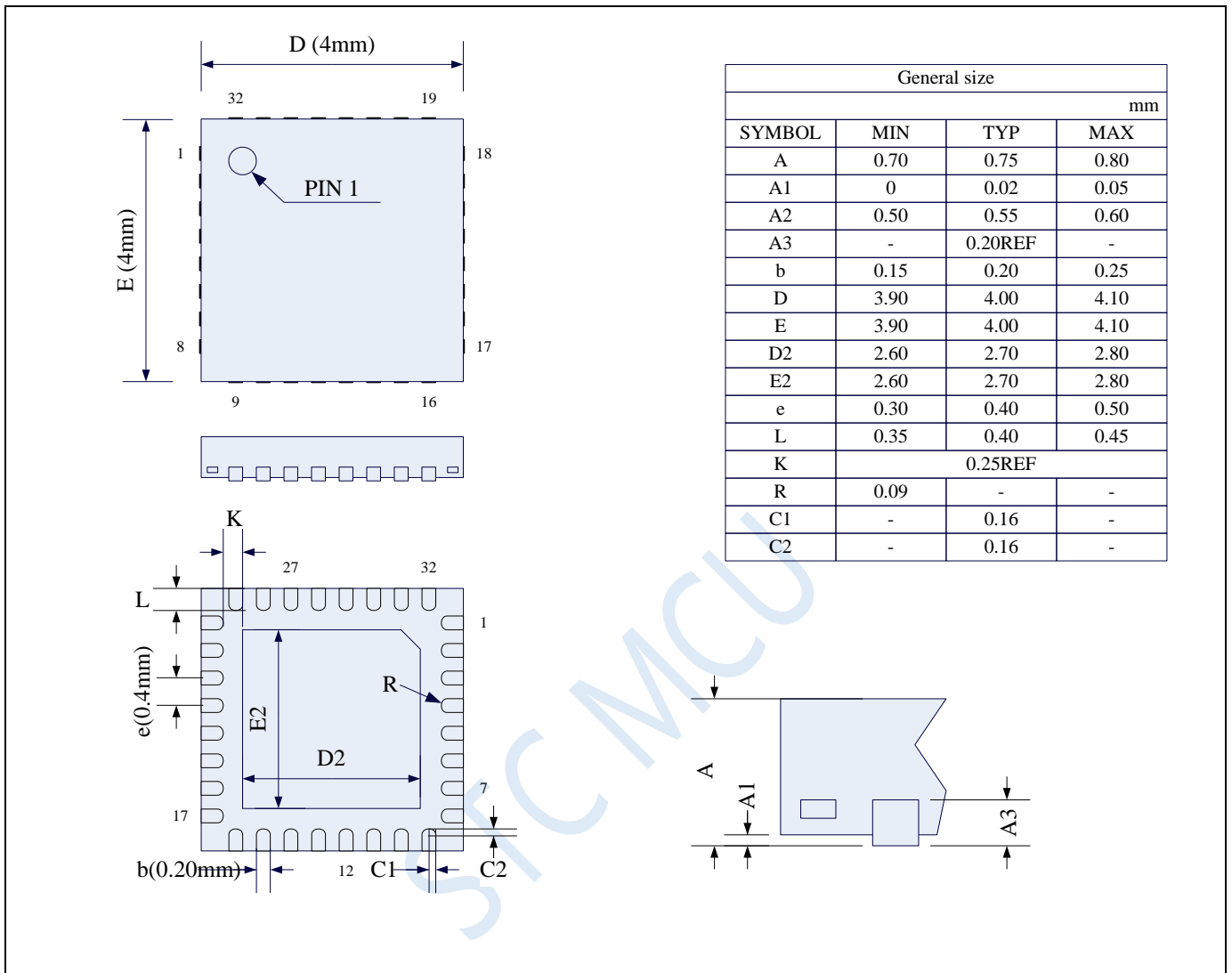
3.1 TSSOP20 Package mechanical data



3.2 LQFP32 Package mechanical data (9mm*9mm)

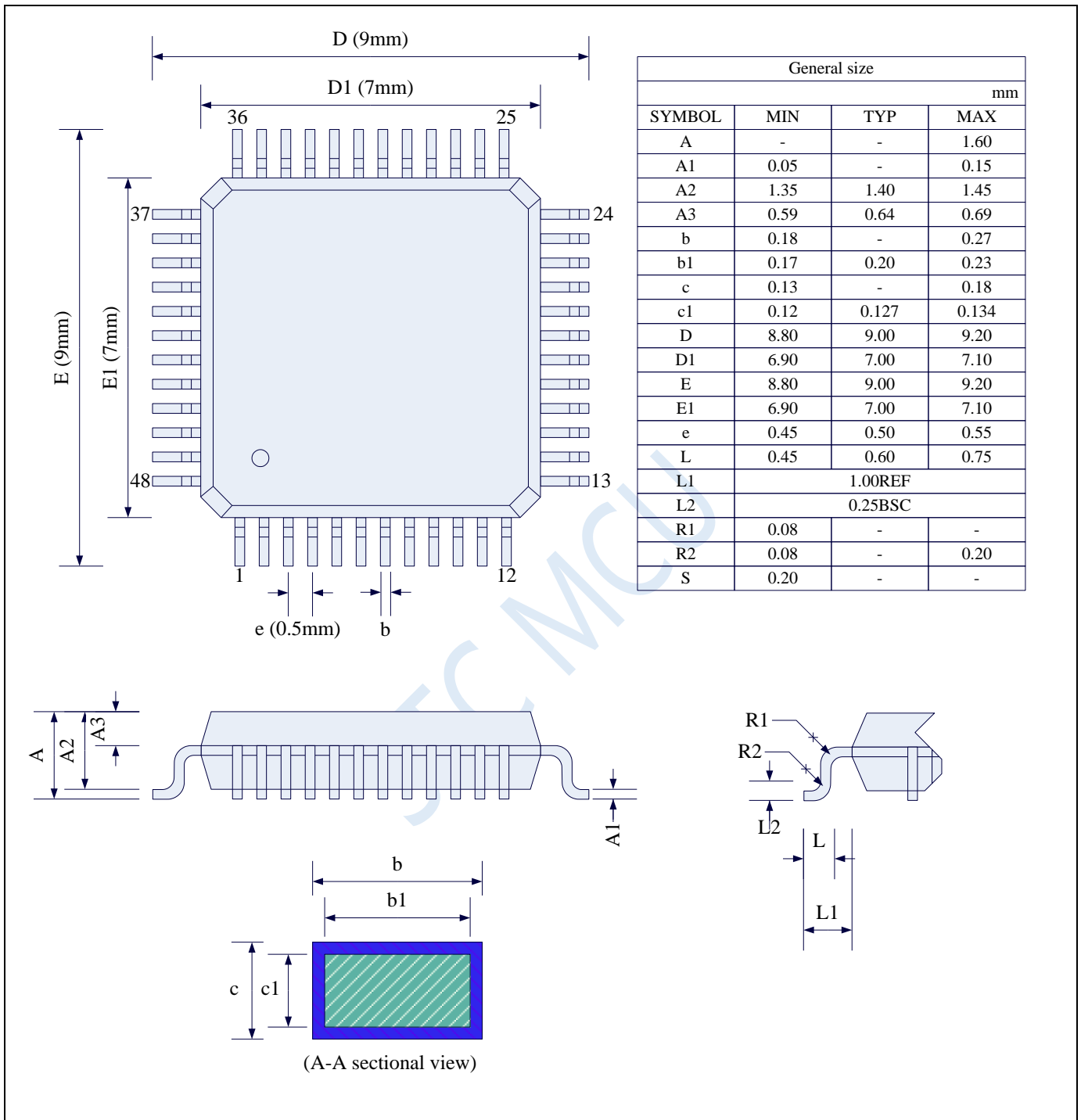


3.3 QFN32 Package mechanical data (4mm*4mm)

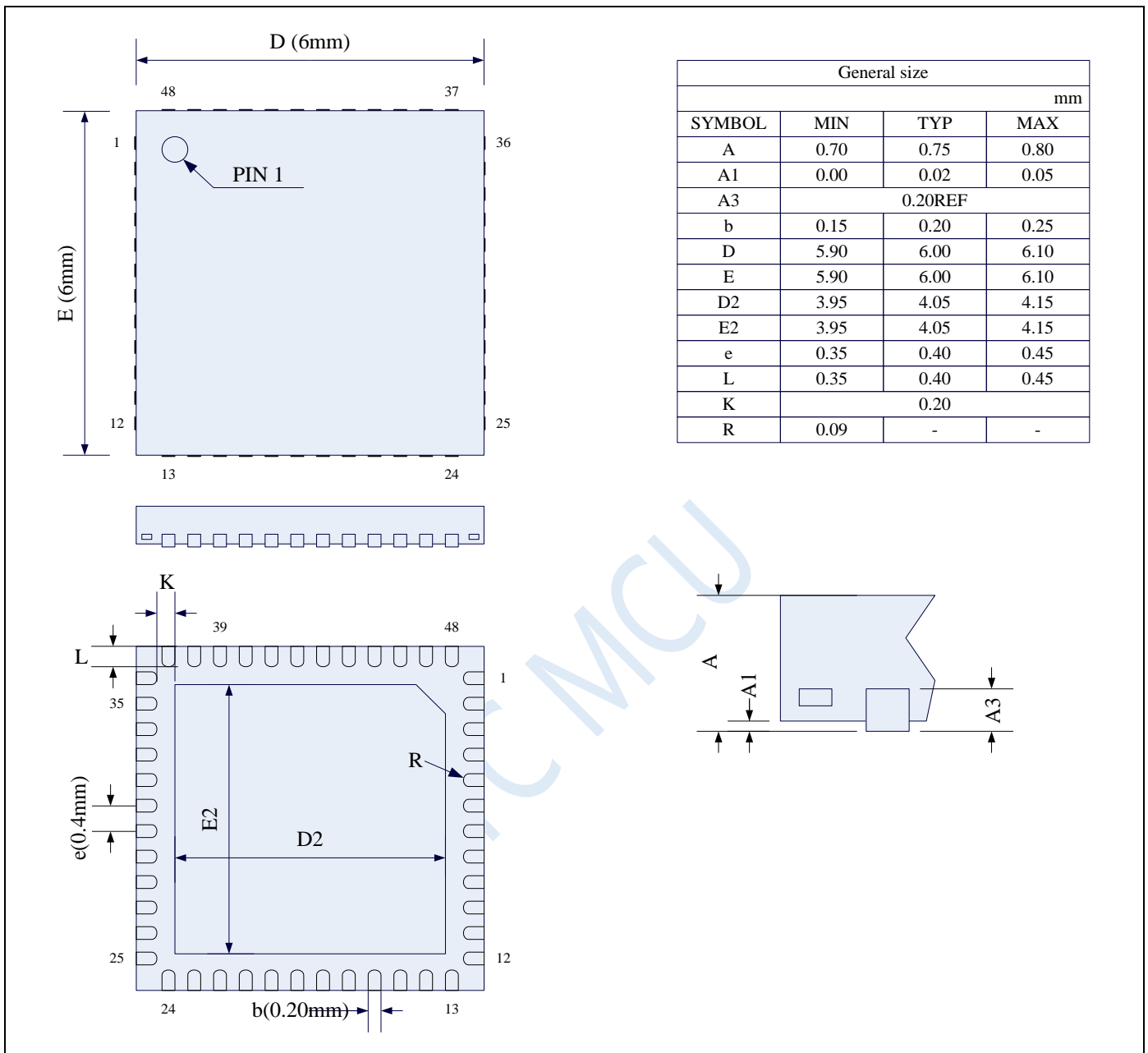


The back metal sheet (substrate) of STC's existing DFN8 packaged chip is not grounded inside the chip. It can be grounded or ungrounded on the user's PCB board, which will not affect the performance of the chip.

3.4 LQFP48 Package mechanical data (9mm*9mm)



3.5 QFN48 Package mechanical data (6mm*6mm)



The back metal sheet (substrate) of STC's existing DFN8 packaged chip is not grounded inside the chip. It can be grounded or ungrounded on the user's PCB board, which will not affect the performance of the chip.

3.6 Naming rules of STC8 family

